

**PATENT ASSIGNMENT**

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Peter Storck	03/17/2009
Martin Vorderwestner	03/17/2009
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	Siltronic AG
<b>Street Address:</b>	Hanns-Seidel-Platz 4
<b>City:</b>	Munich
<b>State/Country:</b>	GERMANY
<b>Postal Code:</b>	81737
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	12406258
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(248)358-3351
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
<b>Phone:</b>	2483584400
<b>Email:</b>	LFreismuth@brookskushman.com
<b>Correspondent Name:</b>	BROOKS KUSHMAN P.C.
<b>Address Line 1:</b>	1000 TOWN CENTER
<b>Address Line 2:</b>	TWENTY-SECOND FLOOR
<b>Address Line 4:</b>	SOUTHFIELD, MICHIGAN 48075
<b>ATTORNEY DOCKET NUMBER:</b>	WSAG 0223 PUSP1
<b>NAME OF SUBMITTER:</b>	Lidia Freismuth
<b>Total Attachments: 1</b> source=Assignment#page1.tif	

CH \$40.00 12406258

**ASSIGNMENT**

For good and valuable consideration, receipt of which is hereby acknowledged, we, **Peter Storck** and **Martin Vorderwestner**, of Moosbrunner Str. 11a, 84489 Burghausen, Germany, and Wang 114, 83567 Unterreit, Germany, respectively, do hereby assign, sell and set over to **Siltronic AG**, a corporation of Germany, located at Hanns-Seidel-Platz 4, 81737 München, Germany, hereinafter referred to as the ASSIGNEE, its successors, assigns or other legal representatives, the entire right, title and interest, domestic and foreign, in and to the inventions and discoveries in

**A Semiconductor Wafer With A Heteroepitaxial Layer and A Method For Producing The Wafer**

including the right of said ASSIGNEE, its successors, assigns or other legal representatives to make applications and to receive Letters Patent for said inventions and discoveries in any and all foreign countries in its or their own name or names, or in our names, at its or their election, and we hereby assign, sell and set over to said ASSIGNEE, its successors, assigns or other legal representatives, all rights of priority, including any provisional applications, in and to said inventions and discoveries in all countries, including all applications claiming benefit of the filing date hereof, continuations, continuations-in-part, divisionals, reexaminations and reissue applications.

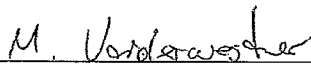
And we hereby agree for ourselves, our heirs, successors, assigns or other legal representatives to execute any and all papers, including applications for Letters Patent of any and all kinds and in any and all countries and to perform any and all acts which said ASSIGNEE, its successors, assigns or other legal representatives may deem necessary to secure thereto the rights herein assigned, sold and set over.

And we hereby represent and warrant that we have not granted any rights inconsistent with the rights granted herein.

Date: March 17, 2009

  
\_\_\_\_\_  
Peter Storck

Date: March 17, 2009

  
\_\_\_\_\_  
Martin Vorderwestner